



MDP1603100RGE04 Information



For Reference Only

Part Number MDP1603100RGE04

Manufacturer Vishay Dale Category Resistors

Resistor Networks, Arrays

Description RES ARRAY 8 RES 100 OHM 16DIP

Package 16-DIP (0.300", 7.62mm)

For the pricing/inventory/lead time, please contact

us

Website: https://www.heisener.com E-mail: salesdept@heisener.com



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MDP1603100RGE04 Specifications

Manufacturer Part Number MDP1603100RGE04 Manufacturer Vishay Dale Category Resistors Package 16-DIP (0.300", 7.62mm) Series MDP Circuit Type Isolated Resistance (Ohms) 100 Tolerance ±2% Number of Resistors 8 Number of Pins 16 Power Per Element 250mW Temperature Coefficient ±100ppm/°C Operating Temperature -55°C ~ 125°C Applications - Mounting Type Through Hole Package / Case 16-DIP (0.300", 7.62mm) Supplier Device Package 16-DIP Size / Dimension 0.850" L x 0.250" W (21.59mm x 6.35mm) Height - Seated (Max) 0.155" (3.94mm)		
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Tolerance ±2% Number of Resistors 8 Number of Pins 16 Power Per Element 250mW Temperature Coefficient ±100ppm/°C Operating Temperature -55°C ~ 125°C Applications - Mounting Type Through Hole Package / Case 16-DIP (0.300", 7.62mm) Supplier Device Package 16-DIP Size / Dimension 0.850" L x 0.250" W (21.59mm x 6.35mm) Height - Seated (Max) 0.155" (3.94mm)	Circuit Type	Isolated
Number of Resistors8Number of Pins16Power Per Element250mWTemperature Coefficient±100ppm/°COperating Temperature-55°C ~ 125°CApplications-Mounting TypeThrough HolePackage / Case16-DIP (0.300", 7.62mm)Supplier Device Package16-DIPSize / Dimension0.850" L x 0.250" W (21.59mm x 6.35mm)Height - Seated (Max)0.155" (3.94mm)	Resistance (Ohms)	100
Number of Pins 16 Power Per Element 250mW Temperature Coefficient ±100ppm/°C Operating Temperature -55°C ~ 125°C Applications - Mounting Type Through Hole Package / Case 16-DIP (0.300", 7.62mm) Supplier Device Package 16-DIP Size / Dimension 0.850" L x 0.250" W (21.59mm x 6.35mm) Height - Seated (Max) 0.155" (3.94mm)	Tolerance	$\pm 2\%$
Power Per Element 250mW Temperature Coefficient ±100ppm/°C Operating Temperature -55°C ~ 125°C Applications - Mounting Type Through Hole Package / Case 16-DIP (0.300", 7.62mm) Supplier Device Package 16-DIP Size / Dimension 0.850" L x 0.250" W (21.59mm x 6.35mm) Height - Seated (Max) 0.155" (3.94mm)	Number of Resistors	8
Temperature Coefficient ±100ppm/°C Operating Temperature -55°C ~ 125°C Applications - Mounting Type Through Hole Package / Case 16-DIP (0.300", 7.62mm) Supplier Device Package 16-DIP Size / Dimension 0.850" L x 0.250" W (21.59mm x 6.35mm) Height - Seated (Max) 0.155" (3.94mm)	Number of Pins	16
Operating Temperature -55°C ~ 125°C Applications - Mounting Type Through Hole Package / Case 16-DIP (0.300", 7.62mm) Supplier Device Package 16-DIP Size / Dimension 0.850" L x 0.250" W (21.59mm x 6.35mm) Height - Seated (Max) 0.155" (3.94mm)	Power Per Element	250mW
Applications - Mounting Type Through Hole Package / Case 16-DIP (0.300", 7.62mm) Supplier Device Package 16-DIP Size / Dimension 0.850" L x 0.250" W (21.59mm x 6.35mm) Height - Seated (Max) 0.155" (3.94mm)	Temperature Coefficient	±100ppm/°C
Mounting Type Through Hole Package / Case 16-DIP (0.300", 7.62mm) Supplier Device Package 16-DIP Size / Dimension 0.850" L x 0.250" W (21.59mm x 6.35mm) Height - Seated (Max) 0.155" (3.94mm)	Operating Temperature	-55°C ~ 125°C
Package / Case 16-DIP (0.300", 7.62mm) Supplier Device Package 16-DIP Size / Dimension 0.850" L x 0.250" W (21.59mm x 6.35mm) Height - Seated (Max) 0.155" (3.94mm)	Applications	-
Supplier Device Package 16-DIP Size / Dimension 0.850" L x 0.250" W (21.59mm x 6.35mm) Height - Seated (Max) 0.155" (3.94mm)	Mounting Type	Through Hole
Size / Dimension 0.850" L x 0.250" W (21.59mm x 6.35mm) Height - Seated (Max) 0.155" (3.94mm)	Package / Case	16-DIP (0.300", 7.62mm)
Height - Seated (Max) 0.155" (3.94mm)	Supplier Device Package	16-DIP
	Size / Dimension	0.850" L x 0.250" W (21.59mm x 6.35mm)
Report errors?	Height - Seated (Max)	0.155" (3.94mm)
		Report errors?

MDP1603100RGE04 Guarantees



Quality Guarantees

We provide 90 days warranty. *

If the items you received were not in perfect quality, we would be responsible for your refund or replacement, but the items must be returned in their original condition.



Service Guarantees

We guarantee 100% customer satisfaction.

Our experienced sales team and tech support team back our services to satisfy all our customers.

MDP1603100RGE04 Payment Methods



















MDP1603100RGE04 Shipping Methods













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